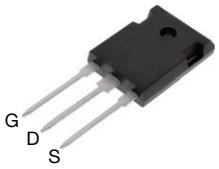
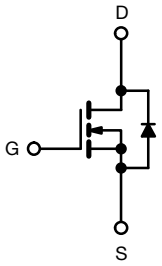
# E Series Power MOSFET With Fast Body Diode

TO-247AD




N-Channel MOSFET

## FEATURES

- Fast body diode MOSFET using E series technology
- Reduced $t_{rr}$, $Q_{rr}$, and $I_{RRM}$
- Low figure-of-merit (FOM): $R_{on}$ x $Q_g$
- Low input capacitance ($C_{iss}$)
- Low switching losses due to reduced $Q_{rr}$
- 175 °C operating temperature
- AEC-Q101 qualified
- Ultra low gate charge ($Q_g$)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

AUTOMOTIVE GRADE

RoHS COMPLIANT

HALOGEN FREE

## APPLICATIONS

- Automotive onboard charger
- Automotive DC/DC converter

| PRODUCT SUMMARY | | |
|---|---|---|
| $V_{DS}$ (V) at $T_J$ max. | 700 | |
| $R_{DS(on)}$ typ. (Ω) at 25 °C | $V_{GS}$ = 10 V | 0.095 |
| $Q_g$ typ. (nC) | 115 | |
| $Q_{gs}$ (nC) | 26 | |
| $Q_{gd}$ (nC) | 44 | |
| Configuration | Single | |

| ORDERING INFORMATION | |
|---|---|
| Package | TO-247AD |
| Lead (Pb)-free and halogen-free | SQW33N65EF-GE3 |

**ABSOLUTE MAXIMUM RATINGS** ($T_C$ = 25 °C, unless otherwise noted)

| PARAMETER | | | SYMBOL | LIMIT | UNIT |
|---|---|---|---|---|---|
| Drain-source voltage | | | $V_{DS}$ | 650 | V |
| Gate-source voltage | | | $V_{GS}$ | ± 30 | |
| Continuous drain current ($T_J$ = 150 °C) | $V_{GS}$ at 10 V | $T_C$ = 25 °C | $I_D$ | 34 | A |
| | | $T_C$ = 100 °C | | 24 | |
| Pulsed drain current [a] | | | $I_{DM}$ | 95 | |
| Linear derating factor | | | | 2.5 | W/°C |
| Single pulse avalanche energy [b] | | | $E_{AS}$ | 508 | mJ |
| Maximum power dissipation | | | $P_D$ | 375 | W |
| Operating junction and storage temperature range | | | $T_J$, $T_{stg}$ | -55 to +175 | °C |
| Drain-source voltage slope | | | dV/dt | 100 | V/ns |
| Reverse diode dV/dt [d] | | | | 50 | |
| Soldering recommendations (peak temperature) [c] | For 10 s | | | 260 | °C |

**Notes**

a. Repetitive rating; pulse width limited by maximum junction temperature
b. $V_{DD}$ = 140 V, starting $T_J$ = 25 °C, L = 28.2 mH, $R_g$ = 25 Ω, $I_{AS}$ = 6.0 A
c. 1.6 mm from case
d. $I_{SD} \leq I_D$, dI/dt = 160 A/µs, starting $T_J$ = 25 °C

| THERMAL RESISTANCE RATINGS | | | | |
|---|---|---|---|---|
| PARAMETER | SYMBOL | TYP. | MAX. | UNIT |
| Maximum junction-to-ambient | $R_{thJA}$ | - | 40 | °C/W |
| Maximum junction-to-case (drain) | $R_{thJC}$ | - | 0.4 | |

| **SPECIFICATIONS** ($T_J$ = 25 °C, unless otherwise noted) | | | | | | | |
|---|---|---|---|---|---|---|---|
| **PARAMETER** | **SYMBOL** | **TEST CONDITIONS** | | **MIN.** | **TYP.** | **MAX.** | **UNIT** |
| **Static** | | | | | | | |
| Drain-source breakdown voltage | $V_{DS}$ | $V_{GS}$ = 0 V, $I_D$ = 250 µA | | 650 | - | - | V |
| $V_{DS}$ temperature coefficient | $\Delta V_{DS}/T_J$ | Reference to 25 °C, $I_D$ = 10 mA | | - | 0.69 | - | V/°C |
| Gate-source threshold voltage (N) | $V_{GS(th)}$ | $V_{DS}$ = $V_{GS}$, $I_D$ = 250 µA | | 2.0 | - | 4.0 | V |
| Gate-source leakage | $I_{GSS}$ | $V_{GS}$ = ± 20 V | | - | - | ± 100 | nA |
| | | $V_{GS}$ = ± 30 V | | - | - | ± 1 | µA |
| Zero gate voltage drain current | $I_{DSS}$ | $V_{DS}$ = 520 V, $V_{GS}$ = 0 V | | - | - | 1 | µA |
| | | $V_{DS}$ = 520 V, $V_{GS}$ = 0 V, $T_J$ = 125 °C | | - | - | 500 | |
| Drain-source on-state resistance | $R_{DS(on)}$ | $V_{GS}$ = 10 V | $I_D$ = 16.5 A | - | 0.095 | 0.109 | Ω |
| Forward transconductance [a] | $g_{fs}$ | $V_{DS}$ = 30 V, $I_D$ = 16.5 A | | - | 13 | - | S |
| **Dynamic** | | | | | | | |
| Input capacitance | $C_{iss}$ | $V_{GS}$ = 0 V, $V_{DS}$ = 100 V, f = 1 MHz | | - | 3972 | - | pF |
| Output capacitance | $C_{oss}$ | | | - | 163 | - | |
| Reverse transfer capacitance | $C_{rss}$ | | | - | 5 | - | |
| Effective output capacitance, energy related [a] | $C_{o(er)}$ | $V_{GS}$ = 0 V, $V_{DS}$ = 0 V to 520 V | | - | 117 | - | |
| Effective output capacitance, time related [b] | $C_{o(tr)}$ | | | - | 482 | - | |
| Total gate charge | $Q_g$ | $V_{GS}$ = 10 V | $I_D$ = 16.5 A, $V_{DS}$ = 520 V | - | 115 | 173 | nC |
| Gate-source charge | $Q_{gs}$ | | | - | 26 | - | |
| Gate-drain charge | $Q_{gd}$ | | | - | 44 | - | |
| Turn-on delay time | $t_{d(on)}$ | $V_{DD}$ = 520 V, $I_D$ = 16.5 A, $R_g$ = 9.1 Ω, $V_{GS}$ = 10 V | | - | 32 | 64 | ns |
| Rise time | $t_r$ | | | - | 51 | 77 | |
| Turn-off delay time | $t_{d(off)}$ | | | - | 134 | 201 | |
| Fall time | $t_f$ | | | - | 62 | 93 | |
| Gate input resistance | $R_g$ | f = 1 MHz, open drain | | 0.4 | 0.9 | 1.8 | Ω |
| **Drain-Source Body Diode Characteristics** | | | | | | | |
| Continuous source-drain diode current | $I_S$ | MOSFET symbol showing the integral reverse p - n junction diode  | | - | - | 34 | A |
| Pulsed diode forward current | $I_{SM}$ | | | - | - | 95 | |
| Diode forward voltage | $V_{SD}$ | $T_J$ = 25 °C, $I_S$ = 16.5 A, $V_{GS}$ = 0 V | | - | 0.9 | 1.2 | V |
| Reverse recovery time | $t_{rr}$ | $T_J$ = 25 °C, $I_F$ = $I_S$ = 16.5 A, dI/dt = 100 A/µs, $V_R$ = 400 V | | - | 178 | 356 | ns |
| Reverse recovery charge | $Q_{rr}$ | | | - | 1.4 | 2.8 | µC |
| Reverse recovery current | $I_{RRM}$ | | | - | 17 | - | A |

**Notes**

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as $C_{oss}$ while $V_{DS}$ is rising from 0 % to 80 % $V_{DS}$

b. $C_{oss(tr)}$ is a fixed capacitance that gives the charging time as $C_{oss}$ while $V_{DS}$ is rising from 0 % to 80 % $V_{DS}$

**TYPICAL CHARACTERISTICS** (25 °C, unless otherwise noted)

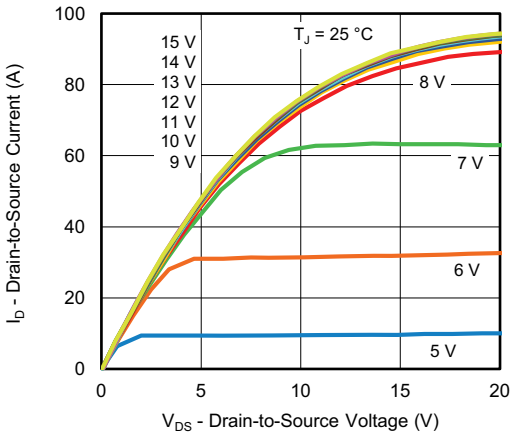



**Fig. 1 - Typical Output Characteristics**

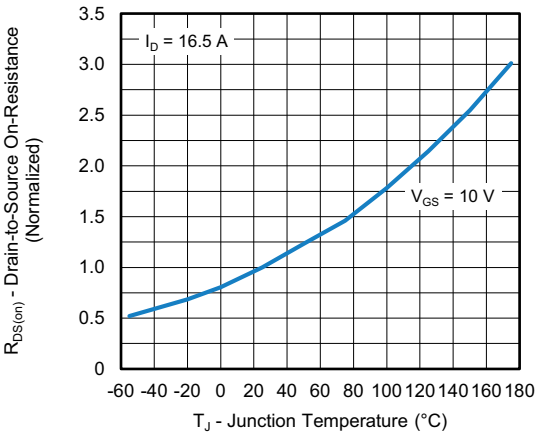



**Fig. 4 - Normalized On-Resistance vs. Temperature**

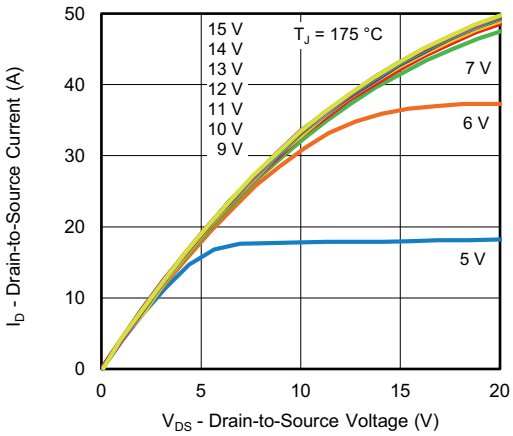



**Fig. 2 - Typical Output Characteristics**

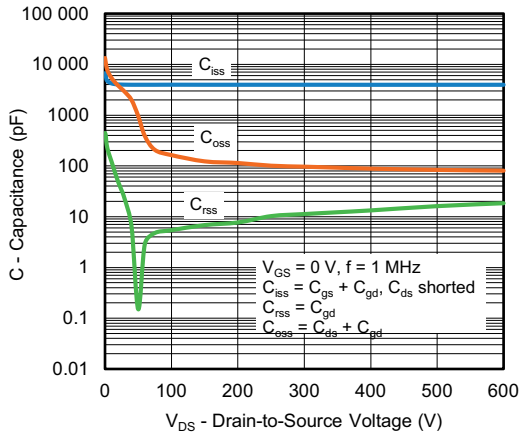



**Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage**

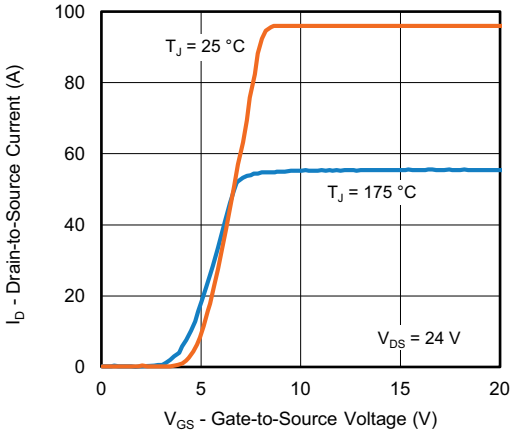



**Fig. 3 - Typical Transfer Characteristics**

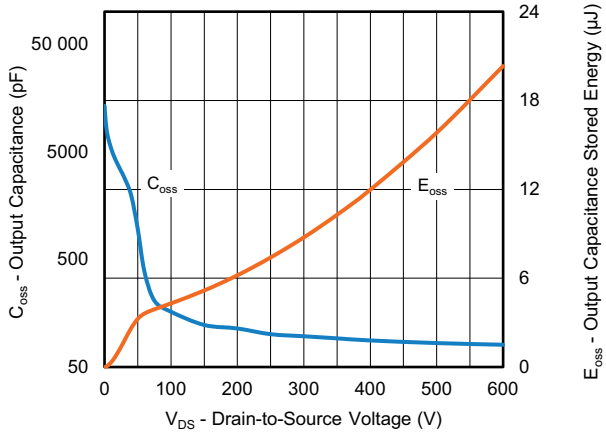



**Fig. 6 - $C_{oss}$ and $E_{oss}$ vs. $V_{DS}$**

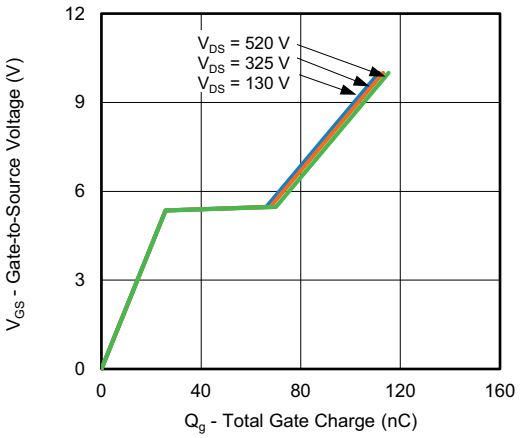



**Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage**

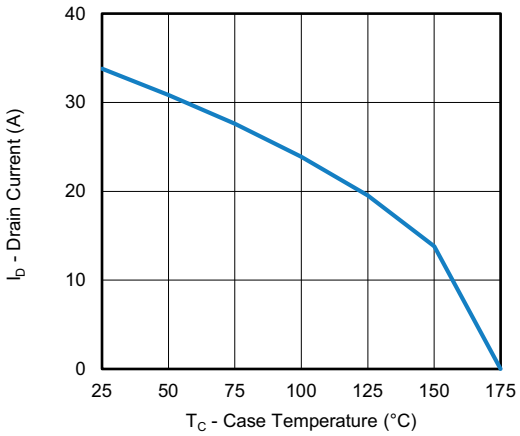



**Fig. 10 - Maximum Drain Current vs. Case Temperature**

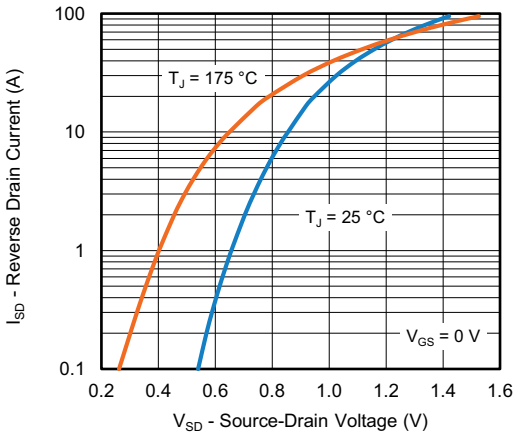



**Fig. 8 - Typical Source-Drain Diode Forward Voltage**

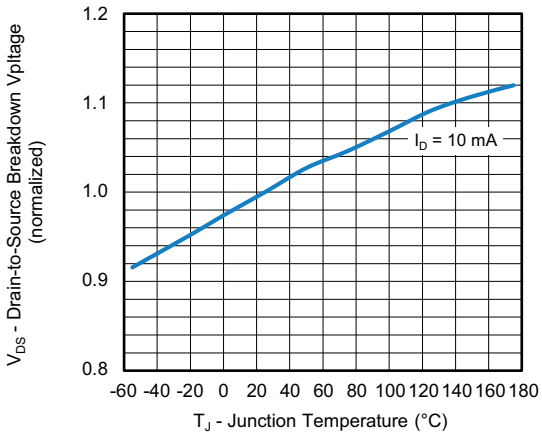



**Fig. 11 - Typical Drain-to-Source Voltage vs. Temperature**

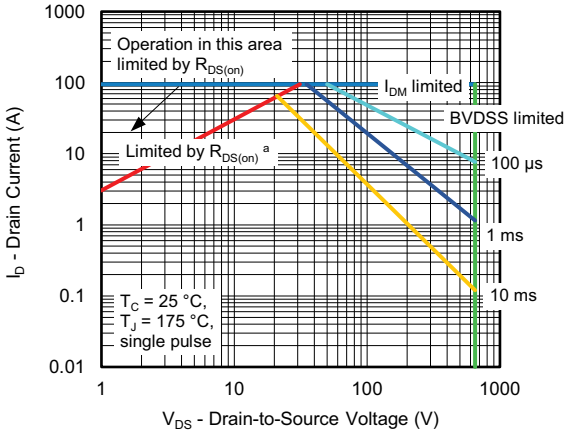



**Fig. 9 - Maximum Safe Operating Area**

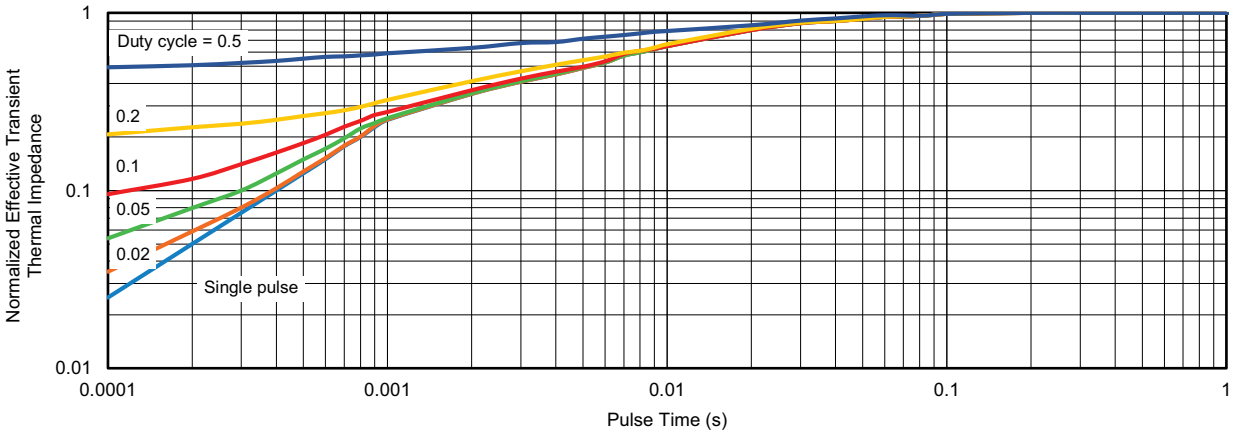



**Fig. 12 - Normalized Thermal Transient Impedance, Junction-to-Case**

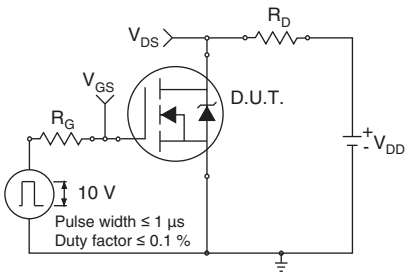



**Fig. 13 - Switching Time Test Circuit**

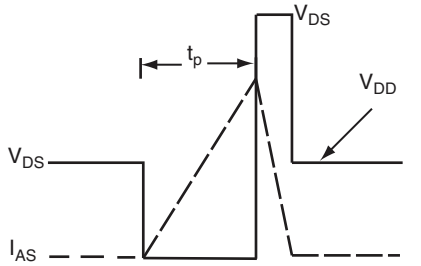



**Fig. 16 - Unclamped Inductive Waveforms**

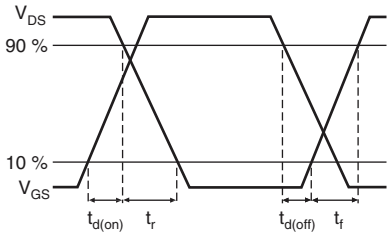



**Fig. 14 - Switching Time Waveforms**

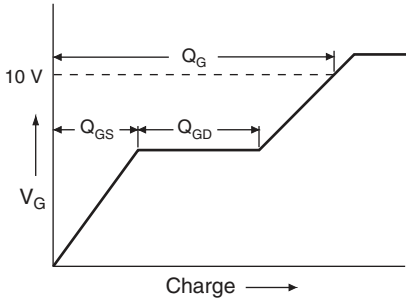



**Fig. 17 - Basic Gate Charge Waveform**

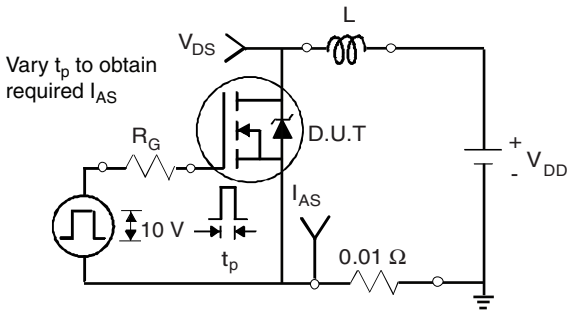



**Fig. 15 - Unclamped Inductive Test Circuit**

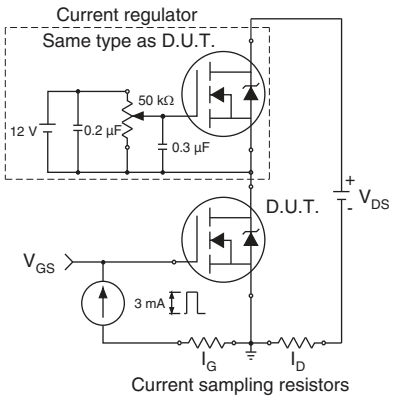
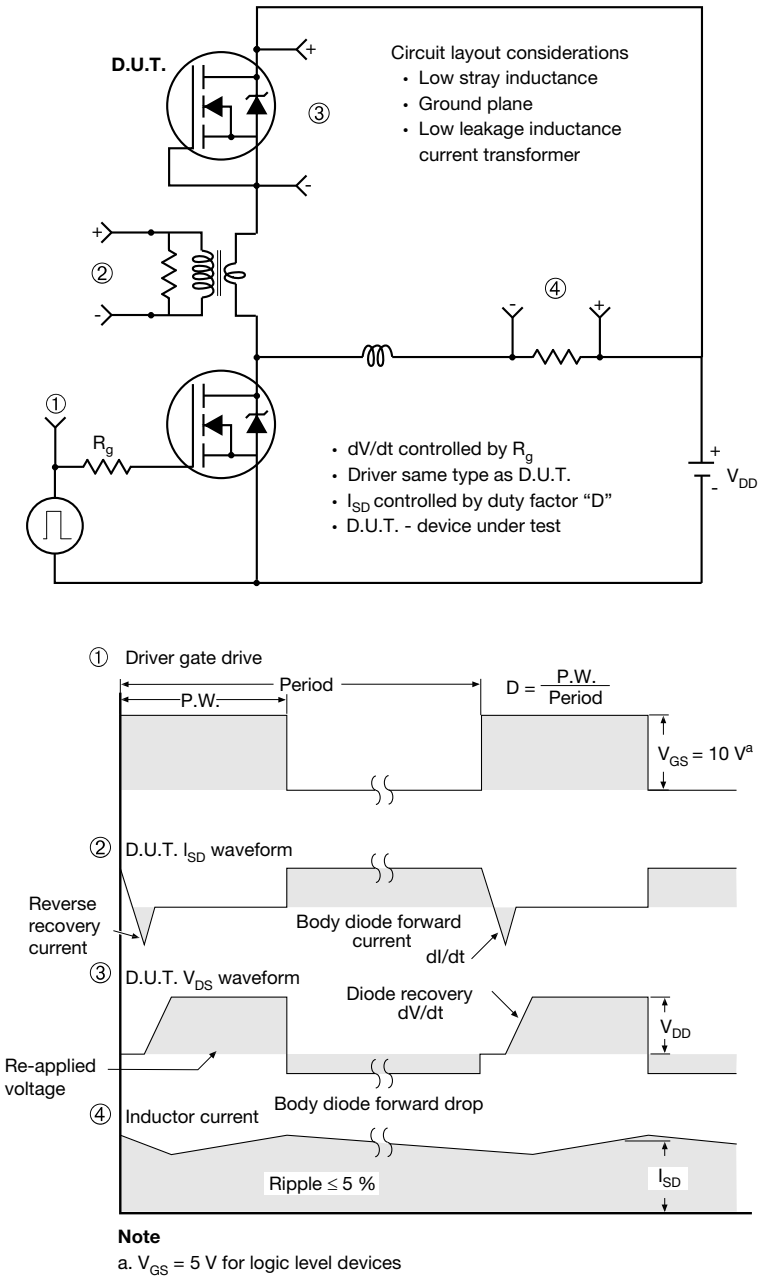



**Fig. 18 - Gate Charge Test Circuit**

**Peak Diode Recovery dV/dt Test Circuit**

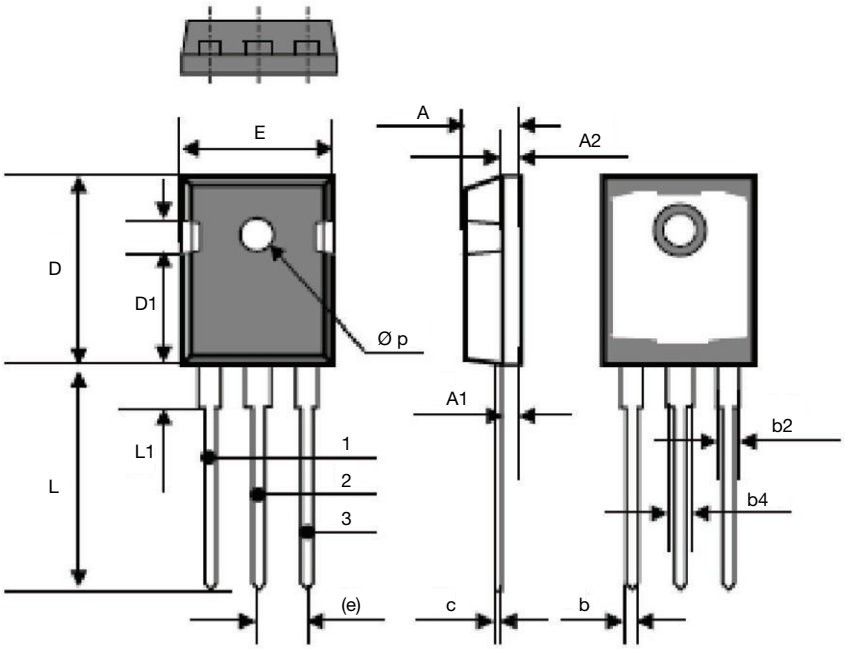



**Note**

a. $V_{GS}$ = 5 V for logic level devices

**Fig. 19 - For N-Channel**

# TO-247AD (High Voltage)




| DIM. | MILLIMETERS | | INCHES | |
|---|---|---|---|---|
| | MIN. | MAX. | MIN. | MAX. |
| A | 4.70 | 5.31 | 0.185 | 0.209 |
| A1 | 2.21 | 2.59 | 0.087 | 0.102 |
| A2 | 1.50 | 2.49 | 0.059 | 0.098 |
| b | 0.99 | 1.40 | 0.039 | 0.055 |
| b2 | 1.65 | 2.41 | 0.065 | 0.095 |
| b4 | 2.59 | 3.43 | 0.102 | 0.135 |
| c | 0.61 BSC | | 0.024 BSC | |
| D | 20.80 | 21.46 | 0.819 | 0.845 |
| D1 | 3.68 | 5.49 | 0.145 | 0.216 |
| (e) | 5.46 BSC | | 0.215 BSC | |
| E | 15.49 | 16.26 | 0.610 | 0.640 |
| L | 19.81 | 20.32 | 0.780 | 0.800 |
| L1 | 4.06 | 4.50 | 0.160 | 0.177 |
| Ø p | 3.51 | 3.66 | 0.138 | 0.144 |
| ECN: S17-0178-Rev. B, 06-Feb-17<br>DWG: 6010 | | | | |

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